



SamHop Microelectronics Corp.

# SDU/D40N03L

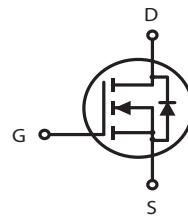
May,2004 ver1.1

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V <sub>DSS</sub>	I <sub>D</sub>	R <sub>DS(ON)</sub> ( m Ω ) Max
30V	42A	10 @ V <sub>GS</sub> = 10V
		16 @ V <sub>GS</sub> = 4.5V

### FEATURES

- Super high dense cell design for low R<sub>DS(ON)</sub>.
- Rugged and reliable.
- TO-252 and TO-251 Package.

SDU SERIES  
TO-252AA(D-PAK)SDD SERIES  
TO-251(I-PAK)

### ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub>=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous @ T <sub>J</sub> =125°C -Pulsed <sup>a</sup>	I <sub>D</sub>	42	A
	I <sub>DM</sub>	105	A
Drain-Source Diode Forward Current	I <sub>S</sub>	40	A
Maximum Power Dissipation @ T <sub>c</sub> =25°C	P <sub>D</sub>	50	W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 175	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	3	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	50	°C/W

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ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DS}}^{\text{SS}}$	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$		10		$\mu\text{A}$
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	$\text{nA}$
<b>ON CHARACTERISTICS<sup>a</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	1	1.5	3	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 20\text{A}$		9	10	$\text{m ohm}$
		$V_{\text{GS}} = 4.5\text{V}, I_{\text{D}} = 10\text{A}$		13	16	$\text{m ohm}$
On-State Drain Current	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 10\text{V}$	40			A
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 10\text{V}, I_{\text{D}} = 20\text{A}$		30		S
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DD}} = 15\text{V}, V_{\text{GS}} = 0\text{V}$ $f = 1.0\text{MHz}$		1375		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$			670		$\text{pF}$
Reverse Transfer Capacitance	$C_{\text{rss}}$			200		$\text{pF}$
<b>SWITCHING CHARACTERISTICS<sup>b</sup></b>						
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}} = 15\text{V}$ $I_{\text{D}} = 1\text{A}$ $V_{\text{GS}} = 10\text{V}$ $R_{\text{GEN}} = 6 \text{ ohm}$		30		ns
Rise Time	$t_r$			32		ns
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$			132		ns
Fall time	$t_f$			30		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 10\text{V}, I_{\text{D}} = 40\text{A}, V_{\text{GS}} = 10\text{V}$		40		$\text{nC}$
		$V_{\text{DS}} = 10\text{V}, I_{\text{D}} = 40\text{A}, V_{\text{GS}} = 4.5\text{V}$		19.5		$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$	$V_{\text{DS}} = 10\text{V}, I_{\text{D}} = 40\text{A}$ $V_{\text{GS}} = 10\text{V}$		8.2		$\text{nC}$
Gate-Drain Charge	$Q_{\text{gd}}$			5.3		$\text{nC}$

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## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS <sup>a</sup>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = 25A$			1.3	V

### Notes

a.Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

b.Guaranteed by design, not subject to production testing.

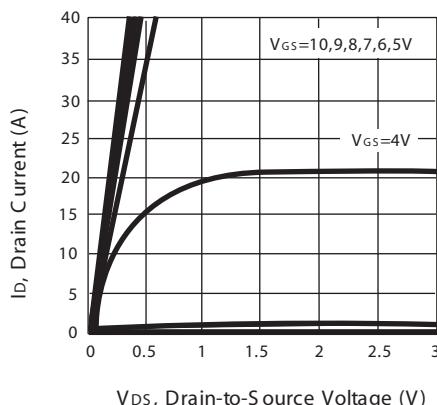


Figure 1. Output Characteristics

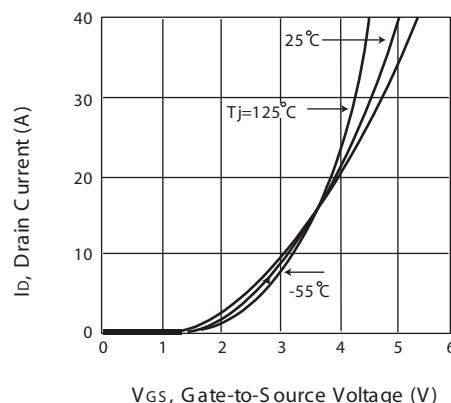


Figure 2. Transfer Characteristics

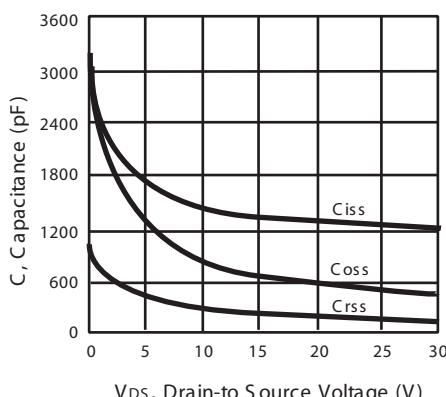


Figure 3. Capacitance

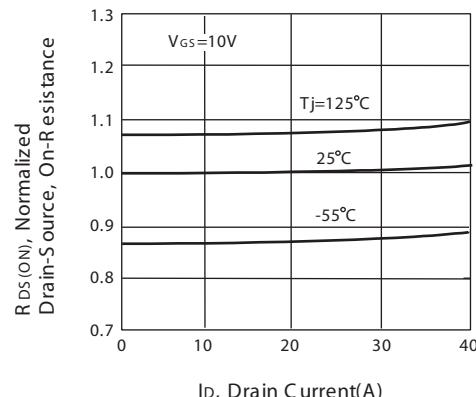


Figure 4. On-Resistance Variation with Drain Current and Temperature

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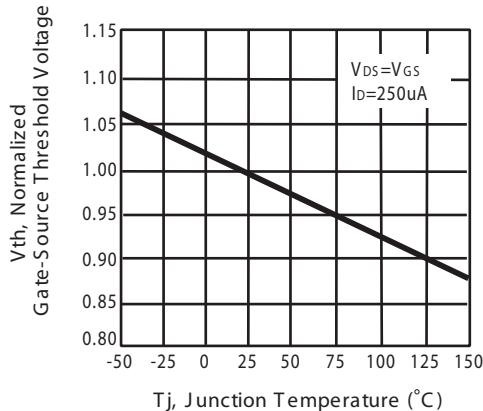


Figure 5. Gate Threshold Variation with Temperature

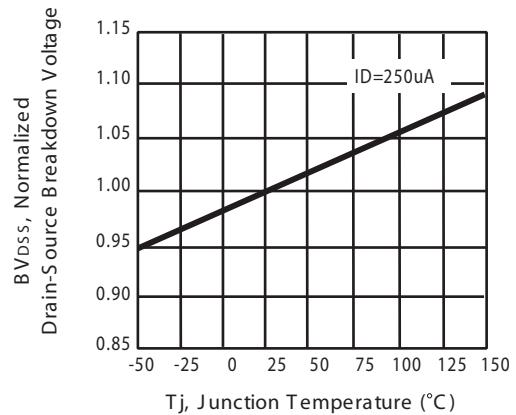


Figure 6. Breakdown Voltage Variation with Temperature

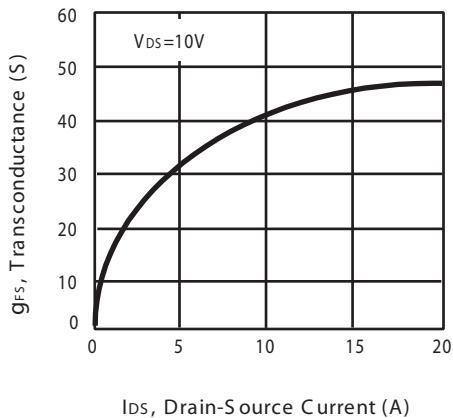


Figure 7. Transconductance Variation with Drain Current

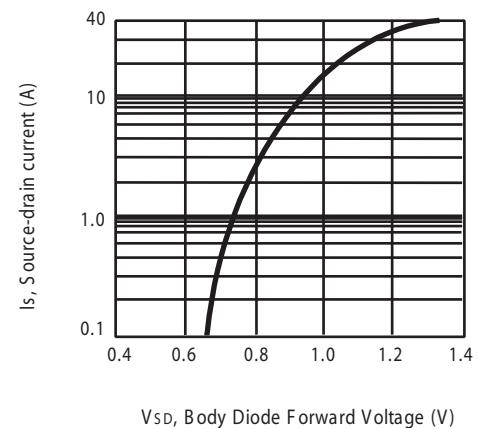


Figure 8. Body Diode Forward Voltage Variation with Source Current

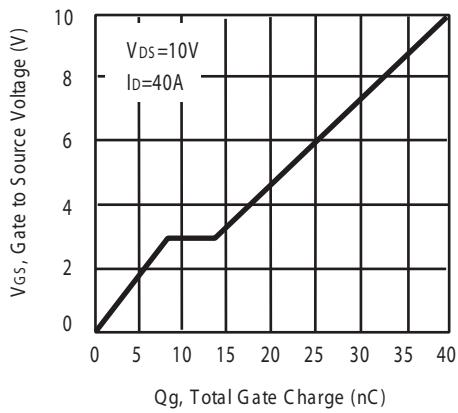


Figure 9. Gate Charge

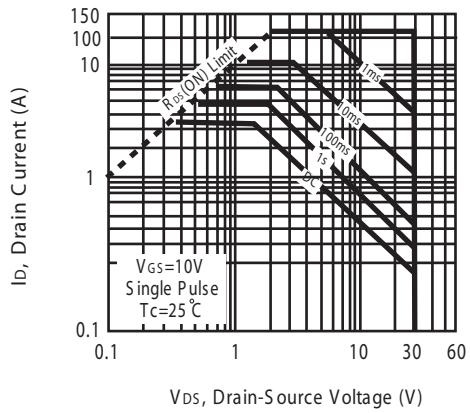
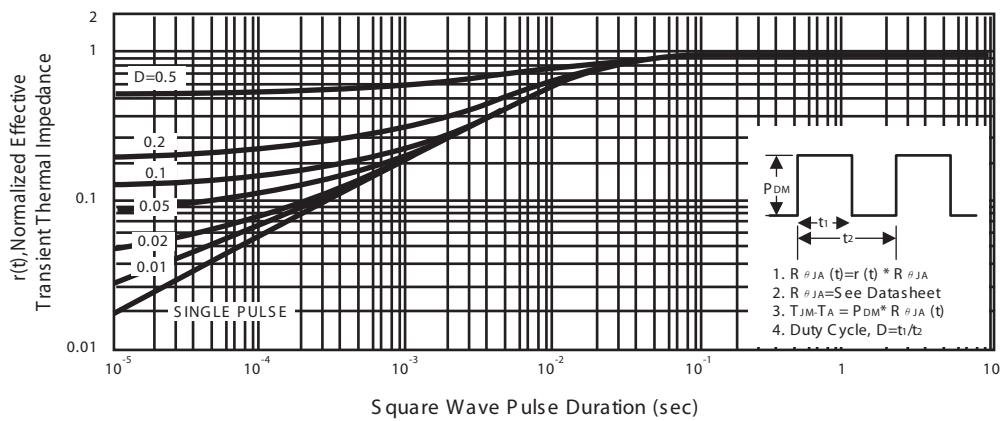
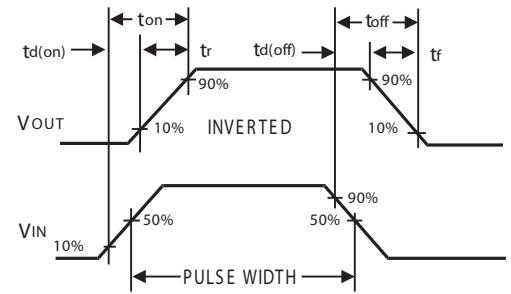
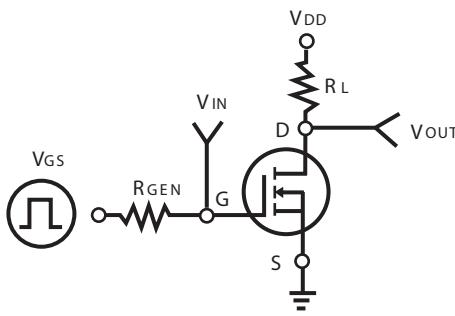


Figure 10. Maximum Safe Operating Area

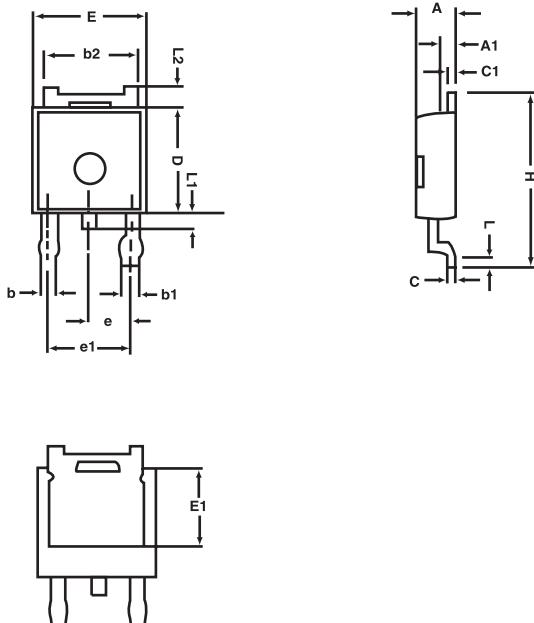
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## PACKAGE OUTLINE DIMENSIONS

TO-252

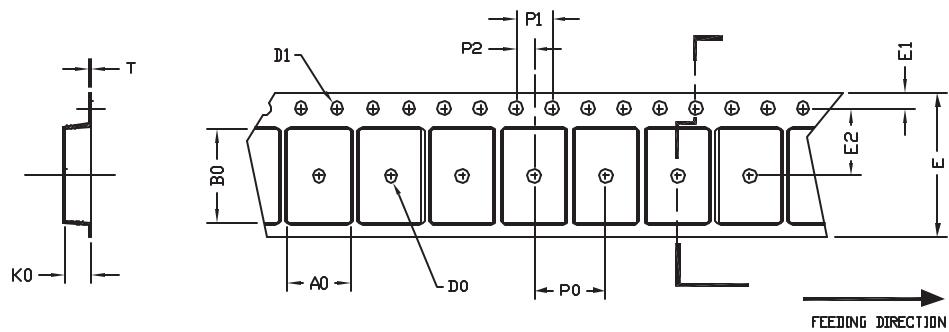


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.25	2.35	0.089	0.093
A1	0.95	1.05	0.037	0.041
b	0.77	0.85	0.030	0.033
b1	0.84	0.94	0.033	0.037
b2	5.30	5.45	0.209	0.215
C	0.49	0.53	0.019	0.021
D	6.00	6.20	0.236	0.244
E	6.40	6.60	0.252	0.260
E1	3.18	3.67	0.125	0.145
e	2.29	BSC	0.090	BSC
H	9.70	10.10	0.382	0.398
L	1.425	1.625	0.056	0.064
L1	0.650	0.850	0.026	0.033
L2	0.600	REF.	0.024	REF.

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## TO-252 Tape and Reel Data

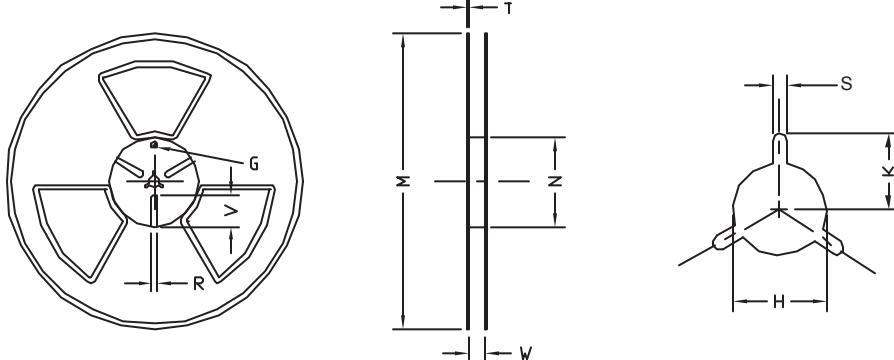
### TO-252 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
TO-252 (16 mm)	6.80 ±0.1	10.3 ±0.1	2.50 ±0.1	ϕ 2	ϕ 1.5 + 0.1 - 0	16.0 0.3±	1.75 0.1±	7.5 ±0.15	8.0 ±0.1	4.0 ±0.1	2.0 ±0.15	0.3 ±0.05

### TO-252 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	T	H	K	S	G	R	V
16 mm	ϕ 330	ϕ 330 ± 0.5	ϕ 97 ± 1.0	17.0 + 1.5 - 0	2.2	ϕ 13.0 + 0.5 - 0.2	10.6	2.0 ± 0.5	---	---	---